Status of CDC (Central Drift Chamber) at Belle II of CDC (Central Drift)
 Shoji Uno (KEK IPNS)

The ^{3rd} DRD1 meeting

The 3rd DRD1 meeting 2024.12.09

Main Features of Belle CDC
ume should be fitted between vertex detector and particle ID devices.

- The volume should be fitted between vertex detector and particle ID devices.
-
- The volume should be fitted between vertex detector and particle ID device
• The conical endplates were machined to meet final focusing magnets.
• A small cell chamber was constructed separately and was installed without • A small cell chamber was constructed separately and was installed without any walls between the main part. • The volume should be fitted between vertex detector and partic
• The conical endplates were machined to meet final focusing magnet
• A small cell chamber was constructed separately and was install
walls between the main
-
-

Functions of CDC

-
- To reconstruct charged tracks
- Measurement of track momentum precisel **Eunctions of CDC**

Fo reconstruct charged tracks

– Measurement of track momentum precisely under magnetic

field

• Position resolution : ∞ 0 1mm field Functions of CE

reconstruct charged tracks

Measurement of track momentum precised

• Position resolution : ~0.1mm

botain information about particle • To reconstruct charged tracks

– Measurement of track momentum precisely under magnetic

field

• Position resolution : ~0.1mm

• To obtain information about particle identification

– Measurement of energy loss in the g Functions of CDC

Fo reconstruct charged tracks

– Measurement of track momentum precisely under mag

field

• Position resolution : ~0.1mm

Fo obtain information about particle identification

– Measurement of energy los • To reconstruct charged tracks

– Measurement of track momentum precisely under magnetic

field

• Position resolution : ~0.1mm

• To obtain information about particle identification

– Measurement of energy loss in the – Measurement of track momentum precisely uno

field

• Position resolution : ~0.1mm

To obtain information about particle identif

– Measurement of energy loss in the gas volume

To provide the trigger signal (L1)

– Mult
	-
- eld

 Position resolution : ~0.1mm

bbtain information about particle iden

leasurement of energy loss in the gas volum

provide the trigger signal (L1)

fulti small cell type for both CDCs

 Shorter maximum drift time

	-
- Position resolution : ~0.1mm

bbtain information about parti

leasurement of energy loss in the g

provide the trigger signal (L1)

lulti small cell type for both CDCs

 Shorter maximum drift time

 Simple trigger log
	- -
		-
	-
	- To obtain information about particle id

	 Measurement of energy loss in the gas vol

	To provide the trigger signal (L1)

	 Multi small cell type for both CDCs

	 Shorter maximum drift time

	 Simple trigger logic

	 Not T France School and School and School and School and School and School and Schotter maximum drift time

	• Shorter maximum drift time

	• Simple trigger logic

	Iot TPC and not Jet cell type

	• Two track separation is not essen for the B factory.

Accuracy on momentum measurement

$$
\left(\frac{\sigma_{Pt}}{Pt}\right)^2 = (aPt)^2 + b^2
$$

$$
a = \frac{\sigma_{r\phi}}{0.3BL^2} \sqrt{\frac{720}{N+5}} \qquad b = \frac{0.054}{LB} \sqrt{\frac{L}{X_0}} \left[1 + 0.038 \ln \frac{L}{X_0}\right]
$$

- B : Magnetic field strength (Tesla)
- L : Measurement lever $ar(m) m$ (Size of chamber)
- $\sigma_{r\phi}$: Measurement error for each point (m)
- N : Number of measurement points
- X_0 : Radiation length in gas volume (m) (material)
- Pt : Transverse momentum (GeV/c)

The parameter (a) is important in higher energy experiment. The parameter (b) is crutial in relatively lower energy experiment.

Pt distribution in B factory

- Pt distribution

 Pt for most of decay

particles in the B factory

is loss than 1 GoV Pt for most of decay
particles in the B factory
is less than 1 GeV. is less than 1 GeV. • Pt for most of decay

particles in the B factory

is less than 1 GeV.

• Less material is a key to

get better momentum

recolution
- get better momentum resolution.

Chamber Gas

- He(50%)-C₂H₆(50%)
for both CDCs • He(50%)-C₂H₆(50%) for both CDCs **Chamber C**

He(50%)-C₂H₆(50%)

: both CDCs

- Longer radiation length(680n

• 0.139% X0 in total gas **Chambe**
 50%)-C₂H₆(50%)

oth CDCs

onger radiation length(680n

• 0.139% X0 in total gas

volume

vift velocity is higher **Example:**

He(50%)-C₂H₆(50%)

• both CDCs

– Longer radiation length(680n

• 0.139% X0 in total gas

volume

– Drift velocity is higher

than other He-based gas.
	-
- volume th CDCs

onger radiation length(680n

• 0.139% X0 in total gas

volume

brift velocity is higher

than other He-based gas.

• Average drift velocity :

– ~3.3cm/µsec in the chambreal.
	- than other He-based gas.

	 Average drift velocity :
 $-23.3 \text{cm}/\mu \text{sec}$ in the chambe – Drift velocity is higher
than other He-based gas.

	• Average drift velocity :

	– ~3.3cm/µsec in the chamber
cell.

	• Maximum drift time :

	– ~400nsec for 18mm cell si

	– Good dE/dx resolution.
		- - cell.
		- -
	-

X-T Curve

- He(50%)-C₂H₆(50%) 45
• B=1.5Tesla 40 • He(50%)-C₂H₆(50%) 450 • He(50%)-C₂H₆(50%)

• B=1.5Tesla

• HV:2.3KV

• HV:2.3KV
-
-
-
- \sim 400nsec

dE/dx Resolution

- The pulse heights for

 The pulse heights for

electron tracks from $\frac{90}{ST}$

were measured for various electron tracks from 90Sr were measured for various 7000 gases. • The pulse heights for

electron tracks from ⁹⁰Sr

were measured for various

gases.

• The resolutions for CH₄

and He(50%)-C₂H₆(50%)
- and He(50%)-C₂H₆(50%) $\frac{5}{8}$ 4000 are same.
- is worse than Ar-based $gas(P-10)$.

Selection of wires **Selection of wire**

eker diameter is better as following

ense wire : Stronger drift field

• Drift velocity tends to saturate

• Diffusion constant smaller

• Lorentz angle smaller

• Lorentz angle smaller

- **Selection of wires**
• Thicker diameter is better as following reasons.
– Sense wire : Stronger drift field **Selection of wire Selection Selection**

– Sense wire : Stronger drift field

– Drift velocity tends to saturate **Selection of wires**

exter diameter is better as following reasor

ense wire : Stronger drift field

• Drift velocity tends to saturate

• Diffusion constant smaller
	- -
		-
		-
	- **Selection of wire:**

	cker diameter is better as following

	ense wire : Stronger drift field

	 Drift velocity tends to saturate

	 Diffusion constant smaller

	 Lorentz angle smaller

	ield wire : Maximum electric field on SCICCHOM OT WITCS

	Thicker diameter is better as following reasons.

	- Sense wire : Stronger drift field

	• Drift velocity tends to saturate

	• Diffusion constant smaller

	• Lorentz angle smaller

	- Field wire : Maximum el cker diameter is better as following reasons.

	Sense wire : Stronger drift field

	• Drift velocity tends to saturate

	• Diffusion constant smaller

	• Lorentz angle smaller

	Field wire : Maximum electric field on the surfac • Drift velocity tends to saturate

	• Diffusion constant smaller

	• Lorentz angle smaller

	ield wire : Maximum electric field on the surface sho

	ess than 20 kV/cm to avoid radiation damage (Malte

	• Au-W 30 µm diameter f iffusion constant smaller
orentz angle smaller
wire : Maximum electric field on the
than 20 kV/cm to avoid radiation dan
au-W 30 µm diameter for sense wire
 $-0.072\% X_0 <$ Al field wire
l (without any plating) 126 µm diame • Lorentz angle smaller

	• Lorentz angle smaller

	ess than 20 kV/cm to avoid radiation damage (Malter effect).

	• Au-W 30 µm diameter for sense wire

	– 0.072% X₀ < Al field wire

	• Al (without any plating) 126 µm diamet wire : Maximum electric field on the surface should than 20 kV/cm to avoid radiation damage (Malter efferring)

	Lu-W 30 µm diameter for sense wire
 $- 0.072\% X_0 \leq AI$ field wire

	1 (without any plating) 126 µm diameter f
		-
		- -0.147% X₀ ~ Chamber Gas (He(50%)-C₂H₆(50%))

Wire configuration

Level shift to match FADC input

Amp-Shaper-Discriminator (ASD) chip

Specifications

Block diagram for readout board

Readout electronics board

CDC readout electronics

Belle-II CDC

Installation into Belle II structure mistanation into Bene II structure
with inner bar without touching Barrel PID Comic ray

Barbar event B-like event

-
-

Performance under 1.5 Tesla magnetic field

The small constant term(b) could be obtained in Belle II CDC.

Pulse height as a function of drift time

Calibration

- The gas gain tends to saturate
for high charge density.
• The track pass though in the for high charge density.
- The gas gain tends to saturate
for high charge density.
• The track pass though in the
chamber perpendicularly ($\cos\theta$
~ 0) and the created ionization chamber perpendicularly $(cos\theta)$ \sim 0) and the created ionization electrons reaches in the small region on the sense wire. Then, the gas gain saturation occurs. • The gas gain tends to saturate
for high charge density.
The track pass though in the
chamber perpendicularly (cos θ
 ~ 0) and the created ionization
electrons reaches in the small
region on the sense wire. Then,
the
- obtain better dE/dx resolution. It is slightly complicate. Since, the saturation effect depend on the amount of energy loss itself.

COSH

dE/dx performance

Radiation damage

- Total accumulated charge had reached up to ~1 C/cm in the inner most layer
for10 years Belle I CDC operation.
- No serious performance degradation had not been observed. for10 years Belle I CDC operation.
	-
- Fotal accumulated charge had reached up to \sim 1 C/cm in the inner m or10 years Belle I CDC operation.
 $-$ No serious performance degradation had not been observed.

For Belle II CDC, total accumulated charge is reaching **•** Total accumulated charge had reached up to \sim 1 C/cm in the inner most layer for 10 years Belle I CDC operation.

– No serious performance degradation had not been observed.

• For Belle II CDC, total accumulated cha the inner most layer.
	-
	- **Example 18 Consumed Solution Consumed Serious Serious Relle I CDC operation.**

	 No serious performance degradation had not been observed.

	 No serious performance degradation had not been observed.

	So Telle II CDC, to **Example 18 Consumed Consumers Consumers Consumers Consumers Consumer Selle I CDC operation.**

	The serious performance degradation had not been observed.

	To Belle II CDC, total accumulated charge is reaching up to ~0.1 C during the past operation. Recently, the trouble was fixed. Then, no difference is observed in the pulse height distribution as comparing with other normal sectors.

Huge injection background

- **Huge injection**
• The continuous injection (top-
up) is adapted in the
SuperKEKB operation to
obtained bisher integrated up) is adapted in the **Huge injection back**
The continuous injection (top-
up) is adapted in the
SuperKEKB operation to
obtained higher integrated
luminosity. obtained higher integrated luminosity. **Huge injection**

The continuous injection (top-

p) is adapted in the

uperKEKB operation to

btained higher integrated

uminosity.

– Belle II are taking data during

the beam injection with the

injection veto. • The continuous injection (top-

up) is adapted in the

SuperKEKB operation to

obtained higher integrated

luminosity.

– Belle II are taking data during

the beam injection with the

injection veto.

• The CDC leak cur
	- the beam injection with the injection veto.
- just after the injection. The CDC condition is not stable. We should manage this situation.

Summary

-
- Belle (I & II) CDC was/is working fine.

 Small constant term for Pt resolution was obtained Summary

Belle (I & II) CDC was/is working fine.

– Small constant term for Pt resolution was obtained using low Z

gas, aluminum field wire and thin inner CFRP wall.

– Good dE/dy resolution gas, aluminum field wire and thin inner CFRP wall. **Summ**

Belle (I & II) CDC was/is wo

– Small constant term for Pt reso

gas, aluminum field wire and th

– Good dE/dx resolution.

Some problems for Belle II C • Belle (I & II) CDC was/is working fine.

– Small constant term for Pt resolution was o

gas, aluminum field wire and thin inner CF

– Good dE/dx resolution.

• Some problems for Belle II CDC.

– Crosstalk Summ

Belle (I & II) CDC was/is wo

- Small constant term for Pt reso

gas, aluminum field wire and t

- Good dE/dx resolution.

Some problems for Belle II C

- Crosstalk

• Inside ASIC chip
 \rightarrow Naw chin was designed and e (I & II) CDC was/is worki
mall constant term for Pt resoluti
as, aluminum field wire and thin
iood dE/dx resolution.
ne problems for Belle II CD(
'rosstalk
• Inside ASIC chip
→New chip was designed and was
→New boards
	-
- - -

 \rightarrow New chip was designed and was tested.

 \rightarrow New boards with new ASIC chips will be installed in the future.

-
- Good dE/dx resolution.

Some problems for Belle II CDC.

 Crosstalk

 Inside ASIC chip

→ New chip was designed and was tested.

→ New boards with new ASIC chips will be installed in the f

 Sudden current increase o
	- From the problems for Belle II CDC.

	From the ASIC chip

	 Inside ASIC chip

	 New boards with new ASIC chips will be installed in the future.

	udden current increase occurred in 2018

	 Have not occurred later after addi From Stalk

	• Inside ASIC chip

	• New chip was designed and was tested.

	• New boards with new ASIC chips will be installed in the future.

	udden current increase occurred in 2018

	• Have not occurred later after adding ~ region. After \sim 3000 ppm water, not occurred. The reason is not clear for me.

Backup

To minimize material To minimize ma **To minimize material**
• Lighter gas (lower pressure)
• Lighter material of wires
• Smaller number of wires **To minimize materi**
• Lighter gas (lower pressure)
• Lighter material of wires
• Smaller number of wires
• Thinner diameter of wires To minimize materia
• Lighter gas (lower pressure)
• Lighter material of wires
• Smaller number of wires
• Thinner diameter of wires

-
-
-
-
-
- Lighter gas (lower pressure)
• Lighter material of wires
• Smaller number of wires
• Thinner diameter of wires
• Better position resolution
• Better resolution of energy loss in gas • Lighter material of wires
• Smaller number of wires
• Thinner diameter of wires
• Better position resolution
• Better resolution of energy loss in gas volume
• Less radiation damage • Smaller number of wires
• Thinner diameter of wires
• Better position resolution
• Better resolution of energy loss in
• Less radiation damage
• Longer stability • Thinner diameter of wires

• Better position resolution

• Better resolution of energy l

• Less radiation damage

• Longer stability

• Easier construction and chea • Better position resolution
• Better resolution of energy loss in gas v
• Less radiation damage
• Longer stability
• Easier construction and cheaper
-
-
-

Selection of gas mixture **Selection of gas mix¹**
• Lower Z (atomic number) gas
– Radiation length is proportional to squa

- -
- **Selection of gas mixture**

Lower Z (atomic number) gas

 Radiation length is proportional to square of Z.

Drift velocity tends to saturate even in low electric **Selection of gas mixture**
• Lower Z (atomic number) gas
– Radiation length is proportional to square of Z.
• Drift velocity tends to saturate even in low electric
field. field. Formance Correct Catomic Correct Conservation Correct Conservation - Radiation length is proportional to square of Z.

Stable performance and less calibration.

Stable performance and less calibration. • Lower Z (atomic number) gas

– Radiation length is proportional to a

• Drift velocity tends to saturate ev

field.

– Stable performance and less calibra

• Smaller diffusion constant

• Better resolution of energy loss • Lower Z (atomic number) gas

– Radiation length is proportional to square

• Drift velocity tends to saturate even in

field.

– Stable performance and less calibration.

• Smaller diffusion constant

• Better resolution - Radiation length is proportions

• Drift velocity tends to saturat

field.

- Stable performance and less ca

• Smaller diffusion constant

• Better resolution of energy lc

• Less radiation damage.
	-
-
-
-

Momentum resolution (Belle I)

The smallest constant term(b) could be obtained in Belle CDC.

Selection of wires II
fwires **Selection o**
• Material of wires
– Sense wire Selection of
Material of wires
– Sense wire
• does not affect on total mate **Selection of wires II**
erial of wires
ense wire
• does not affect on total material so much.
• Au-W (which is used in the world, generally) **Selection of wires** II
erial of wires
ense wire
• does not affect on total material so much.
• Au-W (which is used in the world, generally)
- $30\mu m^6 : 0.072\% X_0 \leq AI$ field wire **Selection of wires**
al of wires
exime
oes not affect on total material so m
u-W (which is used in the world, g
 $-$ 30 μ m^{ϕ} : 0.072% X_0 < Al field wire

- - -
- Material of wires

 Sense wire

 does not affect on total mate

 Au-W (which is used in the

 30 μ m^{ϕ}: 0.072% X₀ < Al i

 Field wire

 Cu-Be : too heavy ense wire

• does not affect on total materia

• Au-W (which is used in the wc
 $- 30 \mu m^{\phi} : 0.072\% X_0 < A1$ field

ield wire

• Cu-Be : too heavy

• Al : Worry about creep \rightarrow

126 um^b: 0.147% X + Chambo • does not affect on total material so much.

• Au-W (which is used in the world, generally)

– 30 μ m^{ϕ}: 0.072% X_0 < Al field wire

ield wire

• Cu-Be : too heavy

• Al : Worry about creep \rightarrow test \rightarrow OK

– 12

 $30\mu m^{\phi}$: 0.072% $X_0 <$ Al field wire

- -
- Au-w (which is used in the world, gener

 30 μ m^{ϕ}: 0.072% X_0 < Al field wire

ield wire

 Cu-Be : too heavy

 Al : Worry about creep \rightarrow test \rightarrow

 126 μ m^{ϕ}: 0.147% $X_0 \sim$ Chamber Gas (He(5

 C :

es not ariet of total material so much.

u–W (which is used in the world, generally)
 $-$ 30μm^φ: 0.072% X₀ < Al field wire

wire

u–Be : too heavy

1 : Worry about creep → test → OK
 $-$ 126 μm^φ: 0.147% X₀ ~ Cha $-126 \mu m^{\phi}$: 0.147% $X_0 \sim$ Chamber Gas (He(50%)-C₂H₆(50%))

-
- ield wire

 Cu-Be : too heavy

 Al : Worry about creep \rightarrow test \rightarrow OK

 126 μ m^{ϕ}: 0.147% $X_0 \sim$ Chamber Gas (He(50%)-C₂H₆(50%))

 C : Diameter is not suitable.

 Be : too difficult to string wire and e

Structure of CDC Structure of CDC

How to support huge total wire tension (more 3 to

How to string many wires?

How much material is allowed for inner cylinder

What value is used for operation gas pressure?

- Absolute pressure or relati

- **Structure of CDC**
• How to support huge total wire tension (more 3 tons)?
• How to string many wires? **Structure of CDC**
• How to support huge total wire tension (more 3 tons)?
• How to string many wires?
• How much material is allowed for inner cylinder?
• What value is used for operation gas pressure? **Structure of CDC**
• How to support huge total wire tension (more 3 tons)?
• How to string many wires?
• How much material is allowed for inner cylinder?
• What value is used for operation gas pressure?
– Absolute pressure • How to support huge total wire tension (more 3 tons)?
• How to string many wires?
• How much material is allowed for inner cylinder?
• What value is used for operation gas pressure?
• Absolute pressure or relative pressu
-
- **Structure of C**
• How to support huge total wire tension
• How to string many wires?
• How much material is allowed for inner
- -
- Fraction Curved aluminum endplate (thinner endplate with 10 mm thickness)

The value is used for operation gas pressure?

Absolute pressure or relative pressure?

The value of solute pressure or relative pressure?

The cur Free String many wires?

How much material is allowed for

What value is used for operation g

— Absolute pressure or relative pressure

Duter cylinder should support who

— Curved aluminum endplate (thinner e

— Pre-stres
	-
	-
- How much material is allowed for inner cylinder?

 What value is used for operation gas pressure?

 Absolute pressure or relative pressure?

 Outer cylinder should support whole wire tension.

 Curved aluminum endpla
	-
- What value is used for operation gas pressure?

 Absolute pressure or relative pressure?

 Outer cylinder should support whole wire tension.

 Curved aluminum endplate (thinner endplate with 10 mm thickness)

 Pre-stre - Absolute pressure or relative pressure?

• Outer cylinder should support whole wire tension.

- Curved aluminum endplate (thinner endplate with 10 mm thickness)

- Pre-stress technique

• One piece of outer CFRP cylinde installed after wire stringing for main part. Duter cylinder should support whole wire tension.
 $-$ Curved aluminum endplate (thinner endplate with 10 mm th
 $-$ Pre-stress technique

Dne piece of outer CFRP cylinder with 5 mm thicknes
 $-$ Thin aluminum sheet (0.1m
	-

Drift Velocity

- Two gas candidates for faster
drift velocity were tested for
Belle II CDC to obtain shorter drift velocity were tested for Belle II CDC to obtain shorter 10 maximum drift velocity. **Drift V**

No gas candidates for faster

lrift velocity were tested for

Belle II CDC to obtain shorter

maximum drift velocity.
 $-$ CH₄ and He-CF₄, higher

n case of He-CF₄, higher

electric field is necessary to • Two gas candidates for faster
drift velocity were tested for
Belle II CDC to obtain shorter
maximum drift velocity.
- CH₄ and He-CF₄, higher
electric field is necessary to
get fast drift velocity. drift velocity were tested for

Belle II CDC to obtain shorter

maximum drift velocity.

– CH₄ and He-CF₄

• In case of He-CF₄, higher

electric field is necessary to

get fast drift velocity.

• In case of CH₄, f
	- CH_4 and He-CF₄
- maximum drift velocity.

 CH₄ and He-CF₄

In case of He-CF₄, higher

electric field is necessary to

get fast drift velocity.

In case of CH₄, faster drift electric field is necessary to $\frac{3}{8}$ ⁶ get fast drift velocity.
- In case of $CH₄$, faster drift velocity by factor two or more 2 can be obtained, even in rather lower electric field. But, Lorentz angle is too larger.

xt curve for new gas in 7mm cell under 1.5 Tesla magnetic field

$He/C₂H₆ = 50/50$

Pure $CH₄$

Diffusion coefficient for one electron

Remark : Rather large for just one electron Diffusion is smaller in higher electric field.

- B : Magnetic field (T)
- E: Electric field (V/m)
- v_0 : (m/s)

Creep test

Wires

-
- Sense wire

 30 μ m^{ϕ} gold-plated W Wires
Sense wire
– 30 μ m^{ϕ} gold-plated W $-30 \mu m^{\phi}$ gold-plated W
-
- Sense wire

 30 μ m^{ϕ} gold-plated W

 Field wire

 126 μ m^{ϕ} Aluminum (A5056 Sense wire
 $- 30 \mu m^{\circ}$ gold-plated W

Field wire
 $- 126 \mu m^{\circ}$ Aluminum (A5056) without any plating • Sense wire
 $-30 \mu m^{\phi}$ gold-plated W

• Field wire
 $-126 \mu m^{\phi}$ Aluminum (A5056

• For both CDCs
-

Cell structure

- **Cell structure**
• Rectangular shape or Hexagonal shape?
– Number of wires **Cell stru

Rectangular shape or Hexago**

– Number of wires

– Goodness of electric field **Cell structure**

Rectangular shape or Hexagonal shap

– Number of wires

– Goodness of electric field

– Pass length difference along drift distane **Cell structure**

Rectangular shape or Hexagonal shape?

- Number of wires

- Goodness of electric field

- Pass length difference along drift distance • Rectangular shape or Hexa

– Number of wires

– Goodness of electric field

– Pass length difference along

• Cell size?

– In case of larger cell size, Rectangular shape or Hexagon

- Number of wires

- Goodness of electric field

- Pass length difference along drif

Cell size?

- In case of larger cell size,

• Number of wires decreases.
	-
	-
	- Increase sof electric field

	ass length difference along drift distance

	size?

	 Number of wires decreases.

	 Increase good electric field region.

	I
- - -
- Fumber of wires

ioodness of electric field

ass length difference along drift dista

size?

i case of larger cell size,

 Number of wires decreases.

 Increase good electric field region
- Size?
• Number of wires decreases.
• Increase good electric field region.
• Higher voltage is required on the sense wires.
• Electric field deceases in the drift region. • Size?
• Number of wires decreases.
• Increase good electric field region.
• Higher voltage is required on the sense wires.
• Electric field deceases in the drift region.
	-

Simulation using Garfield

HV=2.3kV (sense wire) $B = 1.5$ T, $C_2H_5:50\%$ He:50%

Positron drift lines from a wire

Positron drift lines from a wire

Wire configuration 1 **Wire configuration 1**
• Super-layer structure
• 6 layers for each super-layer (Belle II)
– at least 5 layers are required for track reconstruction

-
- Wire configure
• Super-layer structure
• 6 layers for each super-layer (B
	-
- **Wire configuration 1**
Super-layer structure
i layers for each super-layer (Belle II)
- at least 5 layers are required for track reconstruction.
- Even number is preferred for preamp arrangement on
support board to shorten **Wire configuration 1**
Super-layer structure
i layers for each super-layer (Belle II)
- at least 5 layers are required for track reconstruction.
- Even number is preferred for preamp arrangement on
support board to shorten support board to shorten signal cable between feed-through and preamp. • Super-layer structure

• 6 layers for each super-layer (Belle II)

– at least 5 layers are required for track reconstruction.

– Even number is preferred for preamp arrangement on

support board to shorten signal cable b - at least 5 layers are required for track reconstrue

- Even number is preferred for preamp arrangem

support board to shorten signal cable between fe

and preamp.

Additional two layers in inner most super-la

I).

- Hi – Even number is preferred for these reconstruction.

– Even number is preferred for preamp arrangement on support board to shorten signal cable between feed-through and preamp.

Additional two layers in inner most super-l
- II).
	-
	-

Wire configuration 2 (Belle II) **Wire configuration 2 (Belle II)**
• 9 super-layers : 5 axial + 4 stereo(2U+2V)
– A 160*8, U 160*6, A 192*6, V 224*6, **Wire configuration 2 (Belle II)**
9 super-layers : 5 axial + 4 stereo(2U+2V)
- A 160*8, U 160*6, A 192*6, V 224*6,
- A 256*6, U 288*6, A 320*6, V 352*6, A 388*6 **Wire configuration 2 (Belle II)**
9 super-layers : 5 axial + 4 stereo(2U+2V)
– A 160*8, U 160*6, A 192*6, V 224*6,
– A 256*6, U 288*6, A 320*6, V 352*6, A 388*6
Number of layers : 56

- 9 super-layers : 5 axial + 4 stereo(2U+2V)

 A 160*8, U 160*6, A 192*6, V 224*6,

 A 256*6, U 288*6, A 320*6, V 352*6, A 388*6

 Number of layers : 56

 Number of total sense wires : 14336 • 9 super-layers : 5 axial + 4 stereo(2U+2V)

– A 160*8, U 160*6, A 192*6, V 224*6,

– A 256*6, U 288*6, A 320*6, V 352*6, A 388*6

• Number of layers : 56

• Number of total sense wires : 14336

• Number of total wires : • 9 super-layers : 5 axial + 4 stereo(2U+2V)

– A 160*8, U 160*6, A 192*6, V 224*6,

– A 256*6, U 288*6, A 320*6, V 352*6, A 388*6

• Number of layers : 56

• Number of total sense wires : 14336

• Number of total wires :
	-
	-
-
-
-

Deformation of endplate **Deformation of endplate**
• Number of wires increase by factor 2 as compared with Belle I.
– Larger deformation of endplate is expected.
– It may cause troubles in a wire stringing process and other occasions. **Deformation of end**

Number of wires increase by factor 2 as con

– Larger deformation of endplate is expected.

– It may cause troubles in a wire stringing process and Number of holes increases, but a chamber ra

- -
	-
- **Deformation of endplate**

Number of wires increase by factor 2 as compared with Belle I

 Larger deformation of endplate is expected.

 It may cause troubles in a wire stringing process and other occasions.

Number of h **Deformation of endplate**
• Number of wires increase by factor 2 as compared with Belle I.
– Larger deformation of endplate is expected.
– It may cause troubles in a wire stringing process and other occasions.
• Number of Cell size is changing as a function of radius to reduce number of wires. **Sumber of wires increase by factor 2 as compared with Belle I.**

- Larger deformation of endplate is expected.

- It may cause troubles in a wire stringing process and other occasions.

Number of holes increases, but a c **the Solution School School School School School School School Schools**
 Example 11.7% for present CDC
 Example 2011 COCC School Scho the Super-Belle CDC
the Super-Belle COC Super-Belle COC Super-Belle COC Super-Belle COC
the Super-Belle COC
**the fraction of holes increases, but a chamber rac
size is changing as a function of radius t
s.**
he fract − Larger deformation of endplate is expected.

− It may cause troubles in a wire stringing process and other occa

• Number of holes increases, but a chamber radius al

Cell size is changing as a function of radius to r – It may cause troubles in a wire stringing process and other of

Number of holes increases, but a chamber radius

Cell size is changing as a function of radius to revires.

– The fraction of holes respect to total area i Vumber of holes increases, but a chamber r

Cell size is changing as a function of radius

vires.

– The fraction of holes respect to total area is not so difi

present CDC.

• 11.7% for present CDC

• 12.6% for Super-Bell
	- present CDC.
		-
		-
- -
	-
- Cell size is changing as a function of radius to reduce number of
wires.

 The fraction of holes respect to total area is not so different, as comparing with the

present CDC.

 11.7% for present CDC

 12.6% for Superthin aluminum endplate.

Radiation damage

- Radiation damage depends on various condition dramatically. • No problem for usual gas (Argon Methane).
-
- **Example 19 In puriod Concident Control Control Concident**
• No problem for usual gas (Argon Methane).
• Impurity and out gas from chamber material may cause troubles.
• There are two different types of damages on cathod
- Radiation damage depends on various condition dramatically.
• No problem for usual gas (Argon Methane).
• Impurity and out gas from chamber material may cause troubles.
• There are two different types of damages on catho and anode wire surface.
	- Madiation damage depends on various condition dramatically.
No problem for usual gas (Argon Methane).
mpurity and out gas from chamber material may cause troubles.
There are two different types of damages on cathode wire (>20kV/cm), gas multiplication occurs. Then, something accumulate on the surface of the cathode wires quickly. • This is so-called Malter effect. Frequent sparks occur suddenly and the effect and out gas from chamber material may cause troubles.

	• Then effect and de wire surface.

	• Then electric field on the surface of cathode wi mparity and out gas from enamber matched may cause doubles.

	There are two different types of damages on cathode wire surface

	– When electric field on the surface of cathode wire exceeds some level

	(>20kV/cm), gas multip
		- high voltage cannot be supplied.
	- surface of anode wires.

Radiation Damage Test

Main parameters

B^+ \rightarrow Dh^+

 Δ E [GeV]

Electronics for Belle-II CDC

About readout electronics About readout e

For Belle-I CDC,

- S/QT + multi-hit TDC

- S/QT : Q to Time conversion

- FASTBUS TDC was replaced with pipeline **About readout elform**
For Belle-I CDC,
- S/QT + multi-hit TDC
- S/QT : Q to Time conversion
- FASTBUS TDC was replaced with pipeline C **About readout electronics**

For Belle-I CDC,

- S/QT + multi-hit TDC

- S/QT : Q to Time conversion

- FASTBUS TDC was replaced with pipeline COPPER TDC.
 Chree options,

• For Belle-I CDC,

-
-
- **For Belle-I CDC,

For Belle-I CDC,**
 $S/QT + multi-hit TDC$
 $S/QT : Q to Time conversion$
 $FASTBUS TDC was replaced with pipelin$
 Contring Continuity
 Contring Speed FADC(>200MHz)
 $-$ Pipeline TDC + Slow FADC(~20MHz)
 $-$ ASD chip + TMC(or new TDC using FPC For Belle-I CDC,

- S/QT + multi-hit TDC

- S/QT : Q to Time conversion

- FASTBUS TDC was replaced with pipeline COPP
 Three options,

- High speed FADC(>200MHz)

- Pipeline TDC + Slow FADC(~20MHz)

- ASD chip + TMC(or

• Three options,

-
-
- ASD chip + TMC(or new TDC using FPGA) + slow FADC near detector.
ASIC group of KEK Detector Technology Project is developing new ASD
- For Belle-I CDC,
 $S/QT + mult-int TDC$
 $S/QT : Q$ to Time conversion
 $-$ FASTBUS TDC was replaced with pipeline COPPER TDC.
 Chree options,
 $-$ High speed FADC(>200MHz)
 $-$ Pipeline TDC + Slow FADC(~20MHz)
 $-$ ASD chip + TMC(chip.
	- New TDC using FPGA is one candidate for TDC near detector.

Signal Shape

- Each signal shape is not same.
- Rise time : ~10nsec, Pulse width : ~300nsec.
- Maximum drift time : ~300nsec

Signal shape

 $B=1.5T$

arrival time difference > 300nsec

Wire stringing for main part

Vertical stringing

One person could handle wires inside chamber.

One person could access inside to string wires.

51 One person could sit with hanging device without touching the endplate to string wires for the conical part.

Wire stringing for small cell chamber

Horizontal stringing Whole wire tension is supported with thin inner CFRP cylinder.

Sense : Feedthrough

Field : without feedthrough, Al pin only

Installation of small cell chamber

Small cell chamber

Feedthrough

Belle-I CDC small cell chamber

Al pin for field wire $1mm^φ$ Feedthrough for sense wire $3mm^{\circ}$

Al pin for field wire 1.6 mm^{ϕ} + 1.4mm^{ϕ} Feedthrough for sense wire 4mm Belle-II CDC small cell chamber

Material of aluminum pin : A5052 Material of feedthrough : Noryl

Shape and diameter for holes

Belle-I

- 1.0 mm^{ϕ}+ 0.8mm^{ϕ} for field wire
- 3.0mm for sense wire
- Minimum distance between two holes:2.5mm

Belle-II

- 1.6mm^{ϕ} for field wire
- 4.0mm for sense wire

Minimum distance

How to fix the wire

- **•** Wire pass through the hole $(-0.3$ mm^{ϕ}) and is fixed crimping. • Wire pass through the hole $(\sim 0.3 \text{mm}^{\phi})$ and is fixed by **EXECT:** Fig. 1.1 Fig. How to fix the wire
Wire pass through the hole $(\sim 0.3$ mm^{ϕ}) and is fixed by
rimping.
Feedthrough has a taper shape from the gas side.
– We can put the wire easily into the hole of the aluminum pin
with feedthrough fo • Wire pass through the hole

crimping.

• Feedthrough has a taper sh

– We can put the wire easily i

with feedthrough for the ser

• For the field wire,

– There is aluminum pin only Wire pass through the hole $(\sim 0.3 \text{mm}^{\phi})$ and is fixed l

"eedthrough has a taper shape from the gas side.

— We can put the wire easily into the hole of the aluminum

with feedthrough for the sense wire.

"
"
"
"
"
"
- - with feedthrough for the sense wire.
- -
- Feedthrough has a taper shape from the gas side.

 We can put the wire easily into the hole of the aluminum pin

with feedthrough for the sense wire.

For the field wire,

 There is aluminum pin only without feedthrough. aluminum pin directly. But, it is possible for Japanese and a student from Thailand.

Shape of one of feedthroughs

Belle-I CDC small cell chamber

Belle-II CDC small cell chamber

New CDC Gas System

sag calculation

sense wire : 30μm, 50gw

wire length : 2.4 m

wire tension and gravity sag Current Belle CDC **tension and gravity sag**

Current Belle CDC

– wire tension is determined to keep the gravity

sag of sense and field wire same

– 50gy for sense wire and 120gy for field wire **tension and gravity sag**

Current Belle CDC

– wire tension is determined to keep the gravity

sag of sense and field wire same

– 50gw for sense wire and 120gw for field wire

– total tension = (50gw x 8400) + (120gw x **tension and gravity sag**

Current Belle CDC

– wire tension is determined to keep the gravity

sag of sense and field wire same

– 50gw for sense wire and 120gw for field wire

– total tension = (50gw x 8400) + (120gw x

- sag of sense and field wire same
-
- $(x 3) = 3.4$ ton – wire tension is determined to keep the gravity
sag of sense and field wire same
– 50gw for sense wire and 120gw for field wire
– total tension = (50gw x 8400) + (120gw x 8400
x 3) = 3.4 ton
Belle-II
– number of sense wi sag of sense and field wire same
 $-$ 50gw for sense wire and 120gw for field wire
 $-$ total tension = (50gw x 8400) + (120gw x 8400
 x 3) = 3.4 ton

Belle-II
 $-$ number of sense wire: 8400 \rightarrow 14336
 $-$ total tensio – total tension = (50gw x 8400) + (120gw x 8400

x 3) = 3.4 ton

Belle-II

– number of sense wire: 8400 → 14336

– total tension = (50gw x 14336) + (120gw x

14336 x 3) = 6.2 ton @ same weight

– reduce total tension : 1
- Belle-II
	-
	- 14336×3 = 6.2 ton @ same weight
- line design), $6.2 \text{ ton} \rightarrow 4.4 \text{ ton}$ Belle-II

– number of sense wire: 8400 \rightarrow 14336

– total tension = (50gw x 14336) + (120gw x 14336 x 3) = 6.2 ton @ same weight

– reduce total tension : 120gw \rightarrow 80gw (base

line design), 6.2 ton \rightarrow 4.4 ton

– howev
	-

Z

 $r₁$

Belle I CDC

Wire chamber (Belle-CDC)

Inside of chamber During wire stringing

Outside view during electric checking

Structure

- **Structure**
• Belle CDC consists of three parts(Main, Inner and Cathode).
• Curved Aluminum endplates for the main part.
– Thickness : 10mm^t **Structure**
• Belle CDC consists of three parts(Main, Inner and Cate
• Curved Aluminum endplates for the main part.
• Conical endplates for the inner part to give a space for
- -
- St

Belle CDC consists of three parts

Curved Aluminum endplates for the

 Thickness : 10mm^t

Conical endplates for the inner pareomponents. • Belle CDC consists of three parts(Main, Inner and Cathode).
• Curved Aluminum endplates for the main part.
• Thickness : 10mm^t
• Conical endplates for the inner part to give a space for accelerator
components. components.

 5mmt CRFP outer cylinder to support whole tension.

Two thin CFRP cylinder for cathode readout.

 0.4 mm^t x 2

Wire Configuration • Active region
- $R = 88$ mm : inner most sense wire
- $R = 863$ mm : outer most sense wire Wire Configure

Active region

– R= 88mm : inner most sense wire

– R=863mm : outer most sense wire

Wires • Active region

– R= 88mm : inner most sense wire

– R=863mm : outer most sense wire

• Wires

– $30\mu m^{\phi}$ Au-W for sense wire

– $126\mu m^{\phi}$ Al for field wire

- -
	-
- -
	-
- -
- Active region

 R= 88mm : inner most sense wire

 R=863mm : outer most sense wire

 Wires

 30 μ m^{ϕ} Au-W for sense wire

 126 μ m^{ϕ} Al for field wire

 Square cells

 16mm(r)X~18mm(r ϕ)

 6(axial)+5 Active region

- R= 88mm : inner most sense wire

- R=863mm : outer most sense wire

Vires

- 30µm^φ Au-W for sense wire

- 126µm^φ Al for field wire

Square cells

- 16mm(r)X~18mm(rφ)

(axial)+5(stereo) super

ayers • Active region

– R= 88mm : inner most sense wire

– R=863mm : outer most sense wire

• Wires

– 30 μ m^{ϕ} Au-W for sense wire

– 126 μ m^{ϕ} Al for field wire

• Square cells

– 16mm(r)X~18mm(r ϕ)

• 6(axial)+5 layers $R = 863 \text{mm}$: unter most sense wire
 Wires
 $- 30 \mu \text{m}^6 \text{Au-W}$ for sense wire
 $- 126 \mu \text{m}^6 \text{Al}$ for field wire
 Square cells
 $- 16 \text{mm(r)} \text{X} \sim 18 \text{mm(r} \phi)$
 $(axial)+5(\text{stereo}) \text{ super}$
 $ayers$
 $- 50 \text{ layers in total}$
 2eadout channels
 • Wires
 $- 30\mu m^{\phi} Au-W$ for sense wire
 $- 126\mu m^{\phi} Al$ for field wire

• Square cells
 $- 16mm(r)X~18mm(r\phi)$

• 6(axial)+5(stereo) super

layers
 $- 50$ layers in total

• Readout channels
 $- 8400$ for sense wires
 $- 179$ – 30μm^φ Au-W for sense wire

– 126μm^φ Al for field wire

Square cells

– 16mm(r)X~18mm(rφ)

(axial)+5(stereo) super

ayers

– 50 layers in total

Readout channels

– 8400 for sense wires

– 1792 for cathode strips - 126 μ m^{ϕ} Al for field wire

Square cells

- 16mm(r)X~18mm(r ϕ)

((axial)+5(stereo) super

ayers

- 50 layers in total

Readout channels

- 8400 for sense wires

- 1792 for cathode strips
	-
- -
	-

XT Curve & Max. Drift Time

Normal cell(17.3mm) Small cell(5.4mm)

